TOSHIBA Field Effect Transistor Silicon N Channel MOS Type

# SSM3K119TU

Power Management Switch Applications High Speed Switching Applications

1.8 V drive

• Low ON-resistance:

 $R_{on} = 134 \text{ m}\Omega \text{ (max)} (@V_{GS} = 1.8V)$ 

 $R_{on} = 90 \text{ m}\Omega \text{ (max)} (@V_{GS} = 2.5V)$ 

 $R_{on} = 74 \text{ m}\Omega \text{ (max)} (@V_{GS} = 4.0 \text{V})$ 

#### Absolute Maximum Ratings (Ta = 25°C)

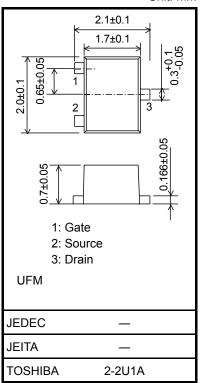
Characterist	ic	Symbol	Rating	Unit	
Drain-source voltage		V <sub>DS</sub>	30	V	
Gate-source voltage		V <sub>GSS</sub>	± 12	V	
Drain current	DC	I <sub>D</sub>	2.5	A	
Drain current	Pulse	I <sub>DP</sub>	5.0		
Drain power dissipation		PD (Note 1)	800	mW	
		PD (Note 2)	500	11100	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature range		T <sub>stg</sub>	-55~150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the

Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

- Note 1: Mounted on a ceramic board.  $(25.4 \text{ mm} \times 25.4 \text{ mm} \times 0.8 \text{ t}, \text{ Cu Pad: } 645 \text{ mm}^2 \text{ )}$  Note 2: Mounted on an FR4 board.
  - (25.4 mm × 25.4 mm × 1.6 t, Cu Pad: 645 mm<sup>2</sup>)

#### Electrical Characteristics (Ta = 25°C)



Weight: 6.6 mg (typ.)

Charact	teristic	Symbol	Test Condition		Min	Тур.	Max	Unit
Drain-source breakdown voltage		V (BR) DSS	$I_D = 1 \text{ mA}, V_{GS} = 0$		30		_	V
		V (BR) DSX	$I_D = 1 \text{ mA}, V_{GS} = -12 \text{ V}$		18		_	V
Drain cutoff curren	t	I <sub>DSS</sub>	$V_{DS} = 30 \text{ V}, \text{ V}_{GS} = 0$				1	μA
Gate leakage curre	ent	I <sub>GSS</sub>	$V_{GS}=\pm~12~V,~V_{DS}=0$		_		±1	μA
Gate threshold vol	tage	V <sub>th</sub>	$V_{DS} = 3 V, I_D = 1 mA$		0.4		1.0	V
Forward transfer a	dmittance	Y <sub>fs</sub>	$V_{DS} = 3 V, I_D = 2 A$	(Note3)	3.8	7.7	_	S
Drain-source ON-resistance		R <sub>DS</sub> (ON)	$I_D = 2.0 \text{ A}, V_{GS} = 4.0 \text{ V}$	(Note3)	_	55	74	mΩ
			$I_D = 1.0 \text{ A}, V_{GS} = 2.5 \text{ V}$	(Note3)		67	90	
			$I_D = 0.5 \text{ A}, V_{GS} = 1.8 \text{ V}$	(Note3)		84	134	
Input capacitance		C <sub>iss</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$		_	270	_	pF
Output capacitance		C <sub>oss</sub>	$V_{DS} = 10 \text{ V}, V_{GS} = 0, f = 1 \text{ MHz}$		_	56	_	pF
Reverse transfer capacitance		C <sub>rss</sub>	$V_{DS} = 10 \text{ V}, \text{ V}_{GS} = 0, \text{ f} = 1 \text{ MHz}$		_	47	_	pF
Switching time	Turn-on time	t <sub>on</sub>	$V_{DD}$ = 10 V, I <sub>D</sub> = 2 A, V <sub>GS</sub> = 0 to 2.5 V, R <sub>G</sub> = 4.7 Ω		_	20	_	ns
	Turn-off time	t <sub>off</sub>			_	31	_	
Drain-source forward voltage		V <sub>DSF</sub>	$I_D = -2.5 \text{ A}, V_{GS} = 0 \text{ V}$	(Note3)		- 0.85	- 1.2	V

Unit: mm

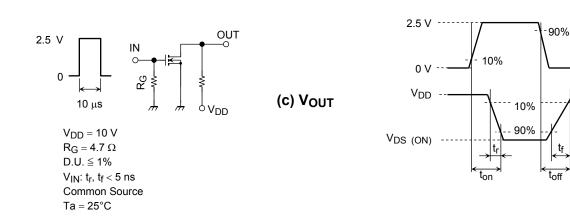
tof

Note3: Pulse test

## Switching Time Test Circuit

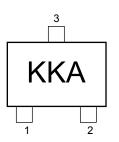
(a) Test Circuit

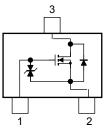
(b) V<sub>IN</sub>



#### Marking

#### Equivalent Circuit (top view)





### Notice on Usage

Vth can be expressed as the voltage between gate and source when the low operating current value is ID = 1 mA for this product. For normal switching operation, V<sub>GS</sub> (on) requires a higher voltage than V<sub>th</sub> and V<sub>GS</sub> (off) requires a lower voltage than Vth.

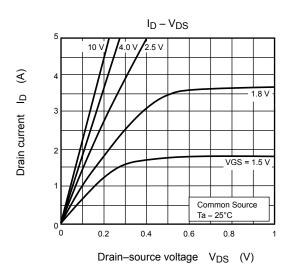
(The relationship can be established as follows: V<sub>GS (off)</sub> < V<sub>th</sub> < V<sub>GS (on)</sub>.)

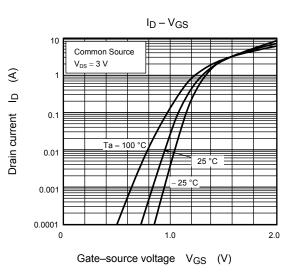
Take this into consideration when using the device.

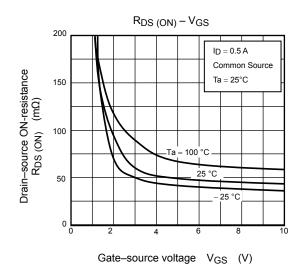
## **Handling Precaution**

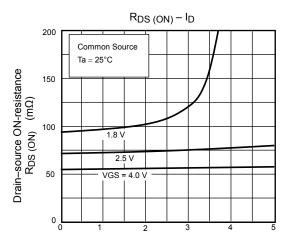
When handling individual devices that are not yet mounted on a circuit board, make sure that the environment is protected against electrostatic discharge. Operators should wear antistatic clothing, and containers and other objects that come into direct contact with devices should be made of antistatic materials.

# **TOSHIBA**

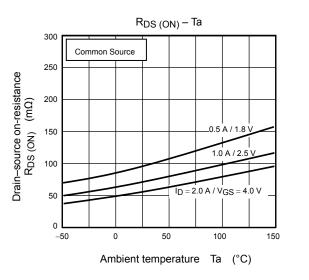


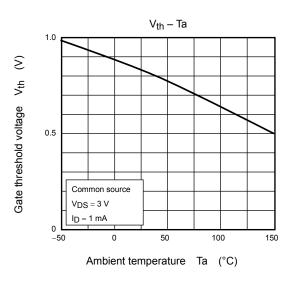




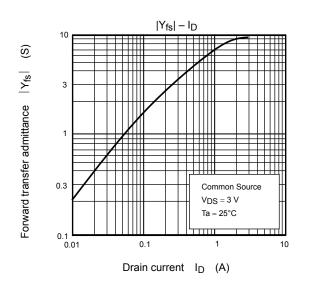


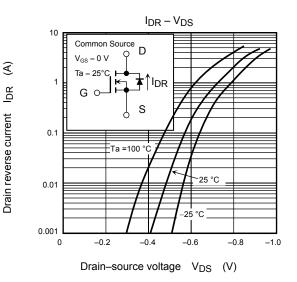


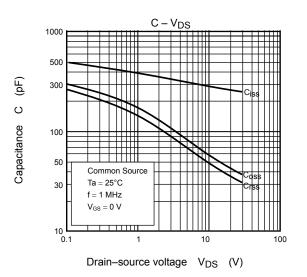


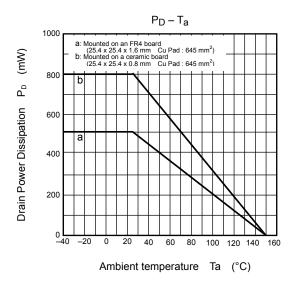


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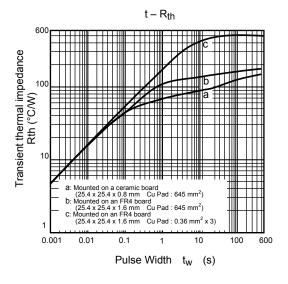








 $t - I_D$ 1000 Common Source V<sub>DD</sub> = 10 V VGS = 0 to 2.5 V Ta = 25°C Switching time t (ns)  $R_G = 4.7 \ \Omega$ 100 10 ton \_ tr 0.01 0.1 10 1 Drain current ID (A)



### **RESTRICTIONS ON PRODUCT USE**

20070701-EN GENERAL

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